## CDC208 DUAL 1-LINE TO 4-LINE CLOCK DRIVER WITH 3-STATE OUTPUTS SCAS109F – APRIL 1990 – REVISED OCTOBER 1998

<ul> <li>Low-Skew Propagation Delay Specifications for Clock-Driver</li> </ul>	DW PACKAGE (TOP VIEW)
Applications	
<ul> <li>TTL-Compatible Inputs and</li> </ul>	
CMOS-Compatible Outputs	1Y3 2 19 1A
<ul> <li>Flow-Through Architecture Optimizes</li> </ul>	1Y4 3 18 1 <u>0E1</u>
PCB Layout	GND 4 17 10E2
	GND 5 16 V <sub>CC</sub>
<ul> <li>Center-Pin V<sub>CC</sub> and GND Pin Configurations Minimize High-Speed</li> </ul>	GND 6 15 V <sub>CC</sub>
	GND <b>[</b> ] 7 14 <b>[</b> ] 2 <u>A</u>
Switching Noise	2Y1 <b>[</b> 8 13 <b>]</b> 2OE1
<ul> <li>EPIC ™ (Enhanced-Performance Implanted</li> </ul>	2Y2 🛛 9 12 🗍 2OE2
CMOS) 1-µm Process	2Y3 🚺 10 🛛 11 🗍 2Y4
<ul> <li>500-mA Typical Latch-Up Immunity at 125°C</li> </ul>	

 Package Options Include Plastic Small-Outline (DW)

#### description

The CDC208 contains dual clock-driver circuits that fanout one input signal to four outputs with minimum skew for clock distribution (see Figure 2). The device also offers two output-enable ( $\overline{OE1}$  and  $\overline{OE2}$ ) inputs for each circuit that can force the outputs to be disabled to a high-impedance state or to a high- or low-logic level independent of the signal on the respective A input.

Skew parameters are specified for a reduced temperature and voltage range common to many applications.

The CDC208 is characterized for operation from -40°C to 85°C.

FUNCTION TABLES							
	INPUTS			OUTI	PUTS		
10E1	10E2	1A	1Y1	1Y2	1Y3	1Y4	
L	L	L	L	L	L	L	
L	L	Н	н	Н	Н	н	
L	Н	Х	L	L	L	L	
н	L	Х	н	Н	н	н	
н	Н	Х	Z	Z	Z	Z	

#### INPUTS OUTPUTS 20E1 20E2 2A 2Y1 2Y2 2Y3 2Y4 L L L L L L L L Н н н Н Н L L н Х L L L L Н L Х Н Н Н Н Н Х Ζ Ζ Ζ Ζ Н



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

EPIC is a trademark of Texas Instruments Incorporated.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

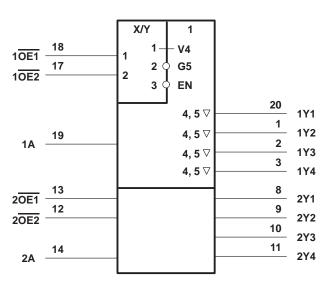


Copyright © 1998, Texas Instruments Incorporated

# **CDC208 DUAL 1-LINE TO 4-LINE CLOCK DRIVER** WITH 3-STATE OUTPUTS

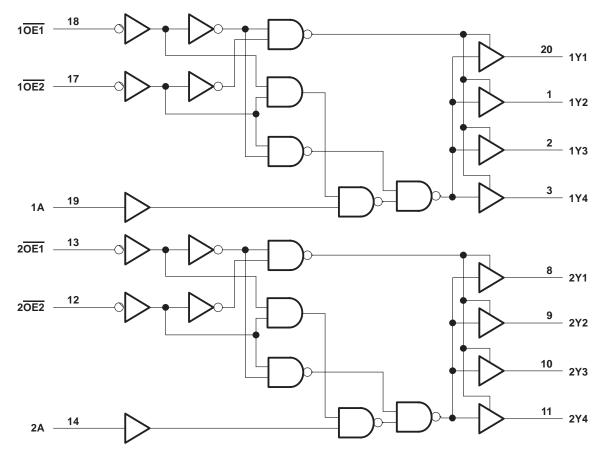
SCAS109F - APRIL 1990 - REVISED OCTOBER 1998

### logic symbol<sup>†</sup>



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

# logic diagram (positive logic)





#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$ Input voltage range, $V_I$ (see Note 1) Output voltage range, $V_O$ (see Note 1) Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ ) Continuous current through $V_{CC}$ or GND Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 2) Storage temperature range	$\begin{array}{ccc} & -0.5 \mbox{ V to } \mbox{V}_{CC} + 0.5 \mbox{ V} \\ & & -0.5 \mbox{ V to } \mbox{V}_{CC} + 0.5 \mbox{ V} \\ & & \pm 20 \mbox{ mA} \\ & & \pm 50 \mbox{ mA} \\ & & & \pm 200 \mbox{ mA} \\ & & & & \pm 1.6 \mbox{ W} \end{array}$
---	--

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABTAdvanced BiCMOS Technology Data Book*, literature number SCBD002B.

#### recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
VIL	Low-level input voltage			0.8	V
VI	Input voltage	0		VCC	V
ЮН	High-level output current			-24	mA
I <sub>OL</sub>	Low-level output current			24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0		10	ns/V
fclock	Input clock frequency			60	MHz
TA	Operating free-air temperature	-40		85	°C



# **CDC208 DUAL 1-LINE TO 4-LINE CLOCK DRIVER** WITH 3-STATE OUTPUTS SCAS109F – APRIL 1990 – REVISED OCTOBER 1998

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	N.s.s	Т	<b>₄ = 25°C</b>	;	MIN	МАХ	UNIT
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX			UNIT
		4.5 V	4.4			4.4		
	$I_{OH} = -50 \mu A$	5.5 V	5.4			5.4		
VOH	1011 - 24 mA	4.5 V	3.94			3.8		V
	$I_{OH} = -24 \text{ mA}$	5.5 V	4.94			4.8		
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85		
	I <sub>OL</sub> = 50 μA	4.5 V			0.1		0.1	
	ΙΟΓ = 30 μΑ	5.5 V			0.1		0.1	V
VOL	I <sub>OL</sub> = 24 mA	4.5 V			0.36		0.44	
		5.5 V			0.36		0.44	
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V					1.65	
lj	$V_{I} = V_{CC}$ or GND	5.5 V			±0.1		±1	μΑ
I <sub>OZ</sub>	$V_{O} = V_{CC}$ or GND	5.5 V			±0.5		±5	μΑ
ICC	$V_{I} = V_{CC} \text{ or GND}, \qquad I_{O} = 0$	5.5 V			8		80	μΑ
$\Delta I_{CC}^{\ddagger}$	One input at 3.4 V, Other inputs at $V_{CC}$ or GND	5.5 V			0.9		1	mA
Ci	$V_I = V_{CC}$ or GND	5 V		4				pF
Co	$V_{O} = V_{CC}$ or GND	5 V		10				pF

<sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

<sup>‡</sup> This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V<sub>CC</sub>.



# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	T <sub>A</sub> = 25°C			MIN	мах	UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX		WAA	UNIT
<sup>t</sup> PLH	1A and 2A	Any Y	5.3	8.5	10.9	5.3	11.7	20
<sup>t</sup> PHL	TA dilu ZA	Ally I	3.6	7.7	11	3.6	11.5	ns
<sup>t</sup> PLH	10E1, 10E2, and	Any Y	4.7	8.5	11.7	4.7	12.8	20
<sup>t</sup> PHL	20E1, 20E2	Ally I	4.4	8.4	11.3	4.4	12.4	ns
<sup>t</sup> PZH	10E2 or 20E2	Any V	4.4	8.1	11.3	4.4	12.4	20
<sup>t</sup> PZL	10E1 or 20E1	Any Y	5	9.6	13.3	5	14.9	ns
<sup>t</sup> PHZ	10E2 or 20E2	Any Y	4.2	7.4	9.3	4.2	10.2	ns
<sup>t</sup> PLZ	10E1 or 20E1		5.4	7.5	9.2	5.4	9.9	115

# switching characteristics, V<sub>CC</sub> = 5 V $\pm$ 0.25 V, T<sub>A</sub> = 25°C to 70°C (see Note 3 and Figures 1 and 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN	МАХ	UNIT
<sup>t</sup> PLH	1A and 2A	Any Y	6.6	10.2	50
<sup>t</sup> PHL	TA and ZA		6.6	9.8	ns
<sup>t</sup> sk(o)	1A and 2A	Any Y		1	ns

NOTE 3: All specifications are valid only for all outputs switching simultaneously and in phase.

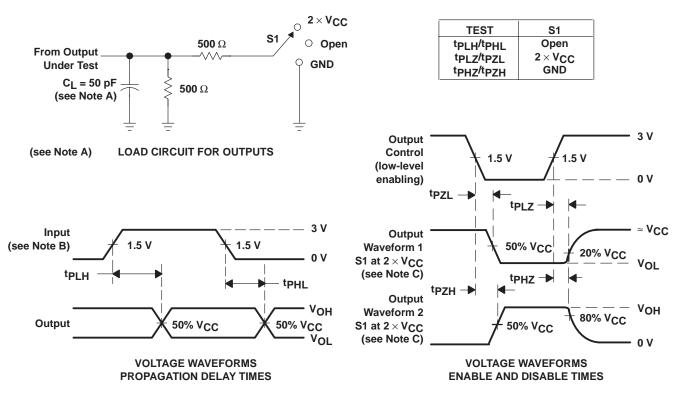
# operating characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

PARAMETER			TEST CONDITIONS	TYP	UNIT
C	Outputs enabled	C <sub>I</sub> = 50 pF, f = 1 MHz	96	~ [	
Cpd	Power dissipation capacitance per bank	Outputs disabled	$C_L = 50 \text{ pF}, \text{ f} = 1 \text{ MHz}$	12	рF



# **CDC208 DUAL 1-LINE TO 4-LINE CLOCK DRIVER** WITH 3-STATE OUTPUTS

SCAS109F - APRIL 1990 - REVISED OCTOBER 1998

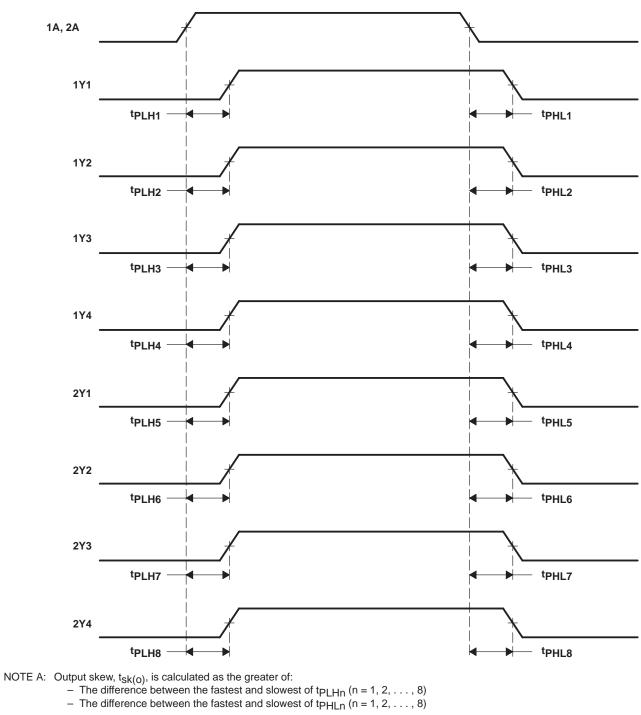


#### PARAMETER MEASUREMENT INFORMATION

- NOTES: A. Cl includes probe and jig capacitance.
  - B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub>  $\leq$  3 ns, t<sub>f</sub>  $\leq$  3 ns. For testing pulse duration:  $t_r = t_f = 1$  to 3 ns. Pulse polarity can be either high-to-low-to-high or low-to-high-to-low.
  - C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

Figure 1. Load Circuit and Voltage Waveforms





# PARAMETER MEASUREMENT INFORMATION

Figure 2. Waveforms for Calculation of  $t_{sk(o)}$ 



# **CDC208 DUAL 1-LINE TO 4-LINE CLOCK DRIVER** WITH 3-STATE OUTPUTS

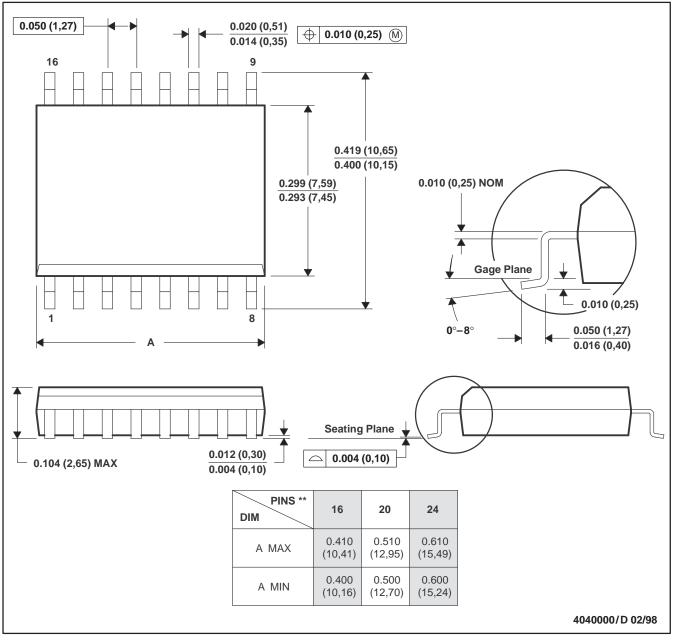
SCAS109F - APRIL 1990 - REVISED OCTOBER 1998

# **MECHANICAL INFORMATION**

PLASTIC SMALL-OUTLINE PACKAGE

# DW (R-PDSO-G\*\*)

**16 PIN SHOWN** 



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013



# PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
CDC208DBLE	OBSOLETE	SSOP	DB	20		TBD	Call TI	Call TI
CDC208DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CDC208DWG4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CDC208DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CDC208DWRG4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CDC208N	OBSOLETE	PDIP	Ν	20		TBD	Call TI	Call TI

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW**: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address:

Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

Copyright © 2005, Texas Instruments Incorporated